

# SWIR SYSTEMS

## Component product series

### SL512

### Standard Linear Array SWIR Camera



Tiin SL512 short-wave infrared (SWIR) line scan camera uses an excellent performance InGaAs sensor, which has extremely high sensitivity in the 0.9~1.7 $\mu$ m bands. The camera's integrated image processing algorithm and low dark current ensure high-quality image effects, and have strong environmental adaptability, low readout noise, extreme dynamic range, low power consumption, stable performance, compact structure, and easy system integration. , Can be widely used in the semiconductor industry, material sorting, industrial inspection, machine vision and other application fields.

### Performance Index

Detector		Interface	
Detector type	InGaAs Focal plane	Optical interface	C
Spectral response	0.9 $\mu$ m~1.7 $\mu$ m	Control interface	UART/USB(2.0)
pixel	512	Digital output	USB/CameraLink
Image spacing	25 $\mu$ m	External trigger	Internal/External
Quantum efficiency	>70%@1.0~1.6 $\mu$ m	Power Supply	
Effective pixel	$\geq$ 99.5%	Power input	DC 12V $\pm$ 3V
Dynamic Range	Low gain: 70dB	Power dissipation	$\leq$ 3.5W
Noise	60e	Environmental Adaptability	
Image		Operating temperature	-20 $^{\circ}$ C~+50 $^{\circ}$ C
Line Rate	19.5KHz	Storage temperature	-30 $^{\circ}$ C~+60 $^{\circ}$ C
Exposure time	$\geq$ 10 $\mu$ s	Physical Properties	
ADC	14bit	Weight	$\leq$ 225g
On-board image processing	Gain control 、 Non-uniform correction ( offset&gain ) 、 Failed pixel replacement 、 Image enhancement (adjustable)	Size	56mm $\times$ 58mm $\times$ 59mm

## Product Features

- Corresponding Band: 900~1700nm
- Detector: 512 resolution InGaAs line array
- Image Spacing: 25um
- Quantum Efficiency: 70%@1.0~1.6um
- High speed, the maximum line frequency can reach 19.5kHz
- High-speed digital interface CameraLink
- High sensitivity, low dark current ,wide dynamic range
- Stable performance, simple operation, easy equipment integration
- Onboard image processing algorithm, provide SDK to support secondary development
- Low power consumption, light weight, compact structure.

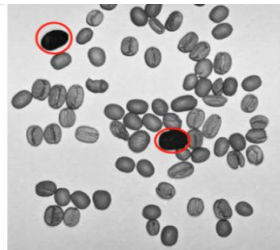
## Product Applications

- Food and Agricultural Products:  
Bruise detection, damage inspection, quality screening, material identification, etc.
- Semiconductor:  
Silicon wafer prototype inspection, solar cell EL/PL inspection, etc.
- Medical Field:  
Optical coherence tomography (OCT)
- Hyperspectral Imaging:  
Composition analysis, waste classification, humidity measurement, fat analysis

## Imaging Effect



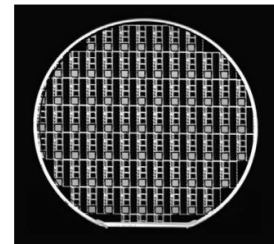
Visible (impurity sorting)



SWIR



Visible (silicon wafer)



SWIR



Shortwave infrared solar wafer defect detection